

FLEX STACK

HTST-125-01-L-DV

(2.54 mm) .100"

TST, HTST, ZST SERIES

SHROUDED .025" SQ POST IDC HEADERS

Mates with:
IDSD, SMSD

SPECIFICATIONS

For complete specifications
www.samtec.com?TST,
www.samtec.com?HTST or
www.samtec.com?ZST

Insulator Material:

TST, ZST: Black Glass
Filled Polyester

HTST: Natural LCP

Insulation Resistance:

5000 MΩ min

Terminal Material:

Phosphor Bronze

Plating: Au or Sn over

50 μ" (1.27 μm) Ni

Current Rating (IDSD/TST):

3.4 A per pin

(2 pins powered)

Operating Temp Range:

-55 °C to +125 °C with Gold

-55 °C to +105 °C with Tin

Flammability Rating: UL 94V-O

Withstanding Voltage:

1000 VRMS

RoHS Compliant: Yes

PROCESSING

Lead-Free Solderable:

HTST: Yes

TST, ZST: Wave Only

SMT Lead Coplanarity:

(0.10 mm) .004" max (05-15)

(0.15 mm) .006" max (17-36)*

*(.004" stencil solution
may be available; contact
IPG@samtec.com)

RECOGNITIONS

For complete scope of
recognitions see
www.samtec.com/quality



FILE NO. E111594

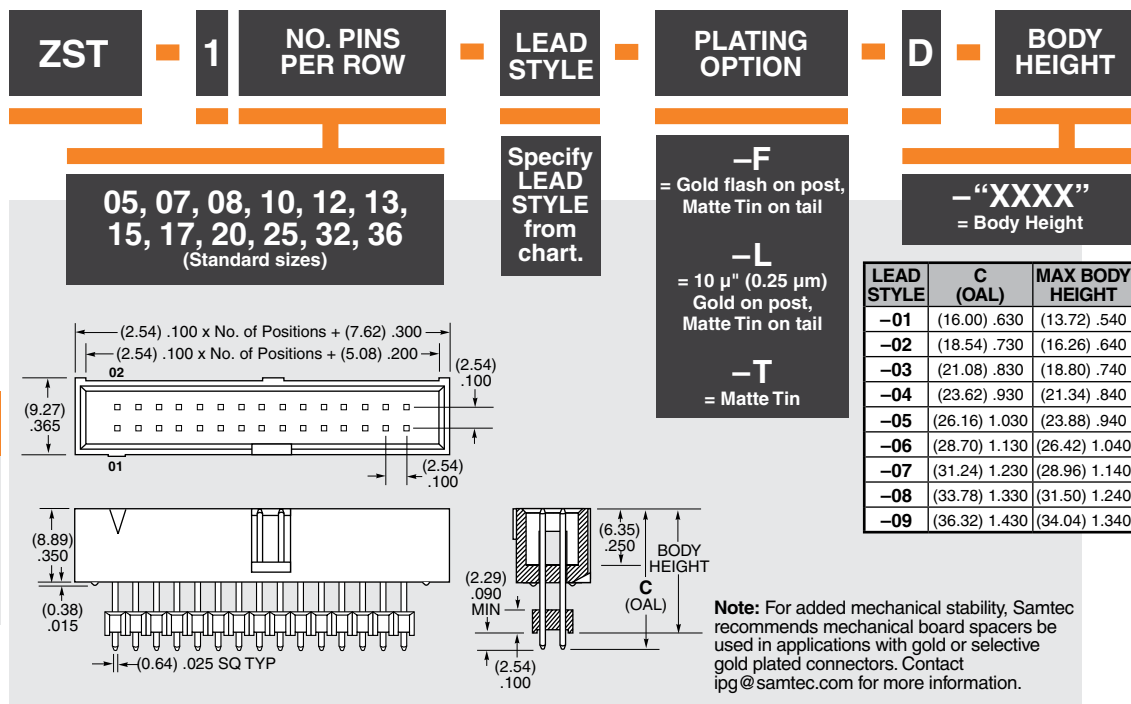
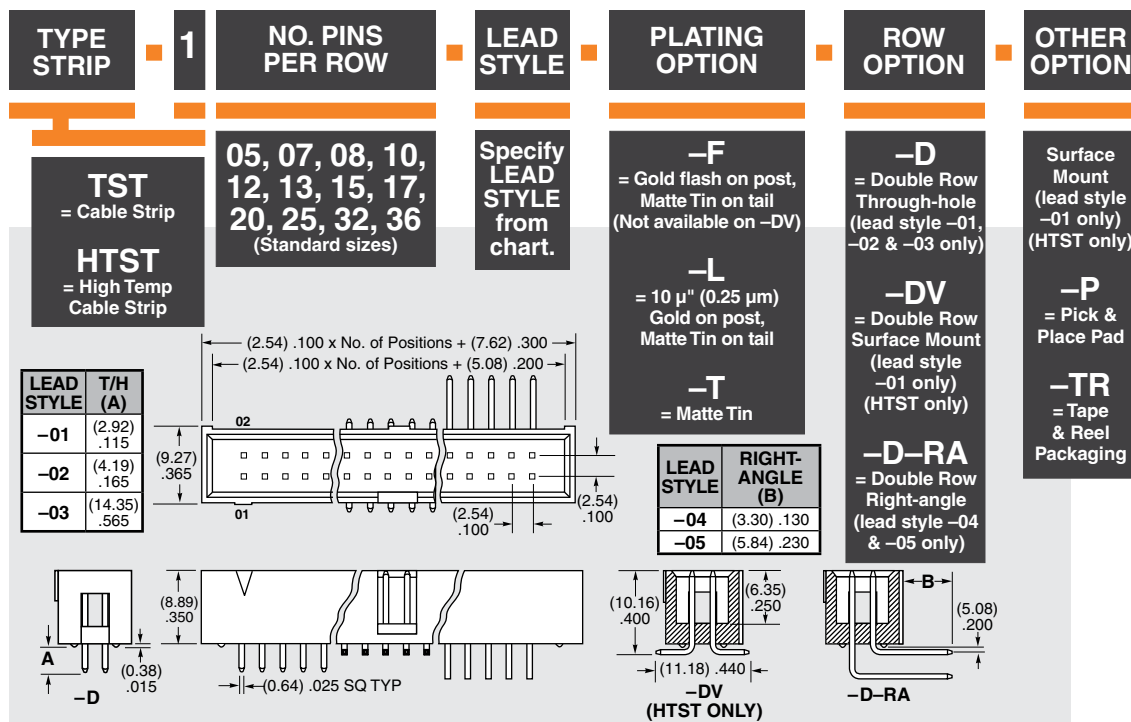
OTHER SOLUTIONS

- Shrouded board-to-board headers and stackers to mate with SSW, SSQ, ESW, ESQ, SSM and BCS Series. See TSS, HTSS and ZSS Series.

ALSO AVAILABLE (MOQ Required)

- Other platings & sizes
- Alignment Pins
- Single Row
- Locking Leads
- Polarized

Note: Some lengths, styles and options are non-standard, non-returnable. ZST is non-standard, non-returnable.



Note: For added mechanical stability, Samtec recommends mechanical board spacers be used in applications with gold or selective gold plated connectors. Contact ipg@samtec.com for more information.

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM

All parts within this catalog are built to Samtec's specifications.

Customer specific requirements must be approved by Samtec and identified in a Samtec customer-specific drawing to apply.